

30 V, 2 A NPN/PNP low VCEsat (BISS) transistor 14 December 2012

**Product data sheet** 

### 1. General description

NPN/PNP low V<sub>CEsat</sub> Breakthrough In Small Signal (BISS) transistor in a leadless medium power DFN2020-6 (SOT1118) Surface-Mounted Device (SMD) plastic package.

NPN/NPN complement: PBSS4230PAN. PNP/PNP complement: PBSS5230PAP.

### 2. Features and benefits

- Very low collector-emitter saturation voltage V<sub>CEsat</sub>
- High collector current capability  ${\sf I}_{\sf C}$  and  ${\sf I}_{\sf CM}$
- High collector current gain h<sub>FE</sub> at high I<sub>C</sub>
- Reduced Printed-Circuit Board (PCB) requirements
- High efficiency due to less heat generation
- AEC-Q101 qualified

### 3. Applications

- Load switch
- Battery-driven devices
- Power management
- Charging circuits
- Power switches (e.g. motors, fans)

### 4. Quick reference data

Table 1. Quie	ck reference data					
Symbol	Parameter	Conditions	Min	Тур	Max	Unit
Per transistor;	for the PNP transistor	with negative polarity				
V <sub>CEO</sub>	collector-emitter voltage	open base	-	-	30	V
I <sub>C</sub>	collector current		-	-	2	А
I <sub>CM</sub>	peak collector current	single pulse; t <sub>p</sub> ≤ 1 ms	-	-	3	А
TR1 (NPN)		·				
R <sub>CEsat</sub>	collector-emitter saturation resistance	$I_{C}$ = 1 A; $I_{B}$ = 100 mA; pulsed; $t_{p} \le 300$ μs; δ $\le 0.02$ ; $T_{amb}$ = 25 °C	-	-	145	mΩ

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Symbol	Parameter	Conditions	Min	Тур	Max	Unit
TR2 (PNP)						
R <sub>CEsat</sub>	collector-emitter saturation resistance	$I_{C}$ = -1 A; $I_{B}$ = -100 mA; pulsed; $t_{p} \le 300$ μs; δ $\le 0.02$ ; $T_{amb}$ = 25 °C	-	-	195	mΩ

### 5. Pinning information

Table 2.	Pinning	information		
Pin	Symbol	Description	Simplified outline	Graphic symbol
1	E1	emitter TR1	6 5 4	C1 B2 E2
2	B1	base TR1		
3	C2	collector TR2	7 8	
4	E2	emitter TR2		
5	B2	base TR2		E1 B1 C2
6	C1	collector TR1	Transparent top view DFN2020-6 (SOT1118)	sym139
7	C1	collector TR1	Britz020-0 (0011110)	
8	C2	collector TR2		

# 6. Ordering information

Table 3. Ordering in	formation		
Type number	Package		
	Name	Description	Version
PBSS4230PANP	DFN2020-6	plastic thermal enhanced ultra thin small outline package; no leads; 6 terminals; body $2 \times 2 \times 0.65$ mm	SOT1118

### 7. Marking

Table 4. Marking codes	
Type number	Marking code
PBSS4230PANP	2J

### 8. Limiting values

#### Table 5. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions		Min	Max	Unit
Per transisto	er transistor; for the PNP transistor with negative polarity					
V <sub>CBO</sub>	collector-base voltage	open emitter		-	30	V
V <sub>CEO</sub>	collector-emitter voltage	open base		-	30	V
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### PBSS4230PANP

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Symbol	Parameter	Conditions	N	lin Max	Unit
V <sub>EBO</sub>	emitter-base voltage	open collector	-	7	V
I <sub>C</sub>	collector current		-	2	А
I <sub>CM</sub>	peak collector current	single pulse; t <sub>p</sub> ≤ 1 ms	-	3	А
I <sub>B</sub>	base current		-	0.3	А
I <sub>BM</sub>	peak base current	single pulse; t <sub>p</sub> ≤ 1 ms	-	1	Α
P <sub>tot</sub>	total power dissipation	T <sub>amb</sub> ≤ 25 °C	[1] -	370	mW
			[2] -	570	mW
			[3] -	530	mW
			[4] -	700	mW
			[5] -	450	mW
			[6] -	760	mW
			[7] -	700	mW
			[8] -	1450	mW
Per device					_
P <sub>tot</sub>	total power dissipation	T <sub>amb</sub> ≤ 25 °C	[1] -	510	mW
			[2] -	780	mW
			[3] -	730	mW
			[4] -	960	mW
			[5] -	620	mW
			[6] -	1040	mW
			[Z] -	960	mW
			<u>[8]</u> -	2000	mW
Tj	junction temperature		-	150	°C
T <sub>amb</sub>	ambient temperature			55 150	°C
T <sub>stg</sub>	storage temperature		-	65 150	°C

Device mounted on an FR4 PCB, single-sided 35 μm copper strip line, tin-plated and standard footprint.
 Device mounted on an FR4 PCB, single-sided 35 μm copper strip line, tin-plated, mounting pad for collector 1 cm<sup>2</sup>.

[3] Device mounted on 4-layer PCB 35 µm copper strip line, tin-plated and standard footprint.

[4] Device mounted on 4-layer PCB 35 µm copper strip line, tin-plated, mounting pad for collector 1 cm<sup>2</sup>.

[5] Device mounted on an FR4 PCB, single-sided 70 µm copper strip line, tin-plated and standard footprint.

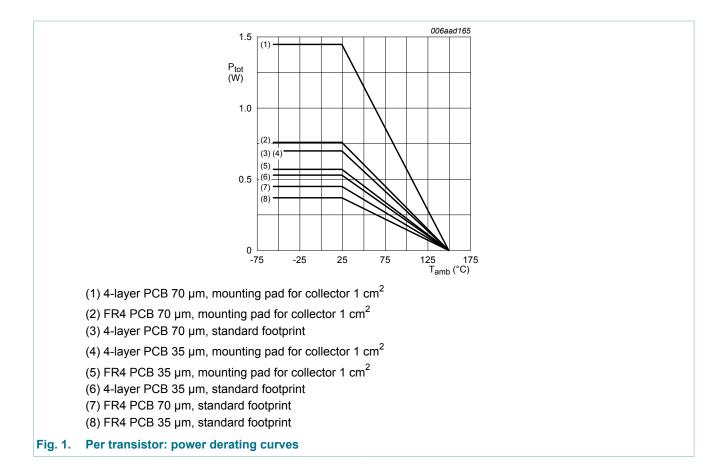
[6] Device mounted on an FR4 PCB, single-sided 70 µm copper strip line, tin-plated, mounting pad for collector 1 cm<sup>2</sup>.

[7] Device mounted on 4-layer PCB 70 µm copper strip line, tin-plated and standard footprint.

<sup>[8]</sup> Device mounted on 4-layer PCB 70 µm copper strip line, tin-plated, mounting pad for collector 1 cm<sup>2</sup>.

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### 9. Thermal characteristics

	Thermal characteristics						
Symbol	Parameter	Conditions		Min	Тур	Мах	Unit
Per transis	tor		·				,
R <sub>th(j-a)</sub> thermal resistance	thermal resistance	in free air	[1]	-	-	338	K/W
	from junction to		[2]	-	-	219	K/W
ampient	ambient		[3]	-	-	236	K/W
		[4] [5] [6] [7] [8]	[4]	-	-	179	K/W
			[5]	-	-	278	K/W
			[6]	-	-	164	K/W
			[7]	-	-	179	K/W
			[8]	-	-	86	K/W
R <sub>th(j-sp)</sub>	thermal resistance from junction to solder point			-	-	30	K/W

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Symbol	Parameter	Conditions		Min	Тур	Max	Unit
Per device							
R <sub>th(j-a)</sub>		in free air	[1]	-	-	245	K/W
from junction to ambient		[2]	-	-	160	K/W	
		[3]	-	-	171	K/W	
		[4] [5]	[4]	-	-	130	K/W
			[5]	-	-	202	K/W
			[6]	-	-	120	K/W
			[7]	-	-	130	K/W
			[8]	-	-	63	K/W

Device mounted on an FR4 PCB, single-sided 35 μm copper strip line, tin-plated and standard footprint.
 Device mounted on an FR4 PCB, single-sided 35 μm copper strip line, tin-plated, mounting pad for collector 1 cm<sup>2</sup>.

[3] Device mounted on 4-layer PCB 35 µm copper strip line, tin-plated and standard footprint.

<sup>[4]</sup> Device mounted on 4-layer PCB 35 µm copper strip line, tin-plated, mounting pad for collector 1 cm<sup>2</sup>.

[5] Device mounted on an FR4 PCB, single-sided 70 µm copper strip line, tin-plated and standard footprint.

[6] Device mounted on an FR4 PCB, single-sided 70 µm copper strip line, tin-plated, mounting pad for collector 1 cm<sup>2</sup>.

[7] Device mounted on 4-layer PCB 70 µm copper strip line, tin-plated and standard footprint.

[8] Device mounted on 4-layer PCB 70 µm copper strip line, tin-plated, mounting pad for collector 1 cm<sup>2</sup>.

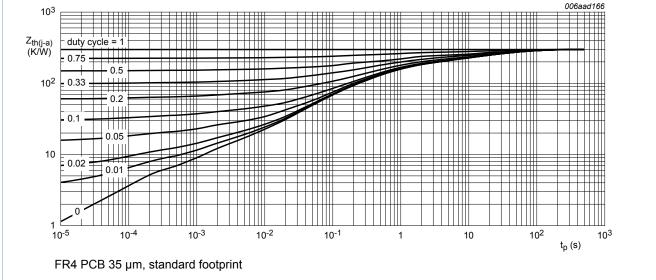
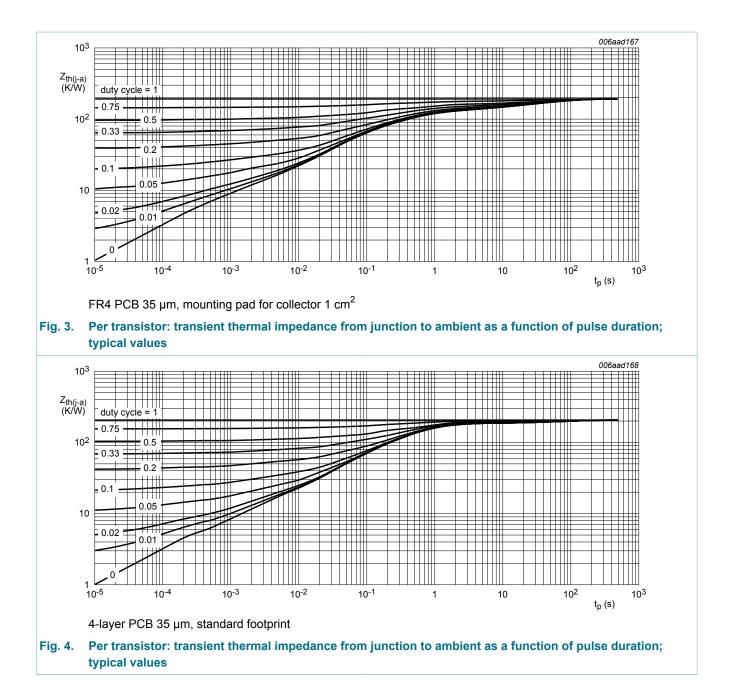


Fig. 2. Per transistor: transient thermal impedance from junction to ambient as a function of pulse duration; typical values

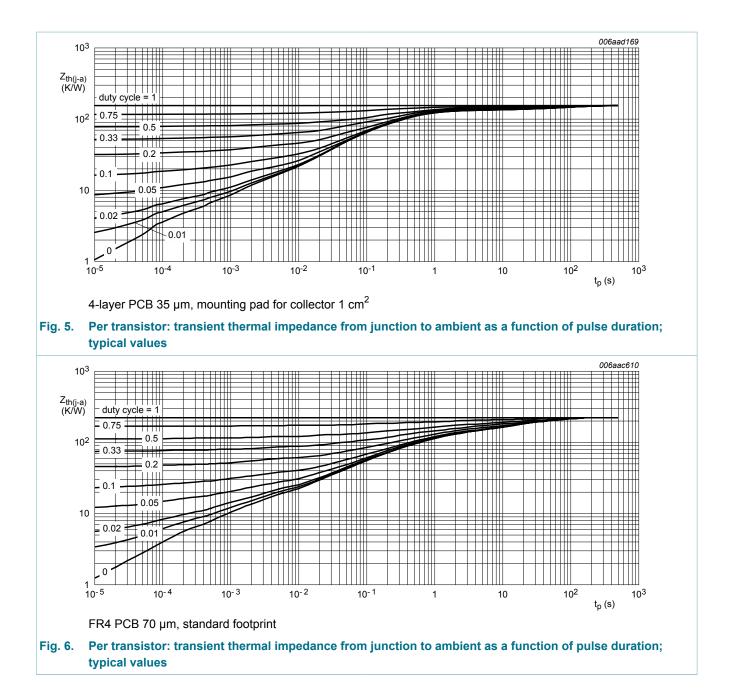


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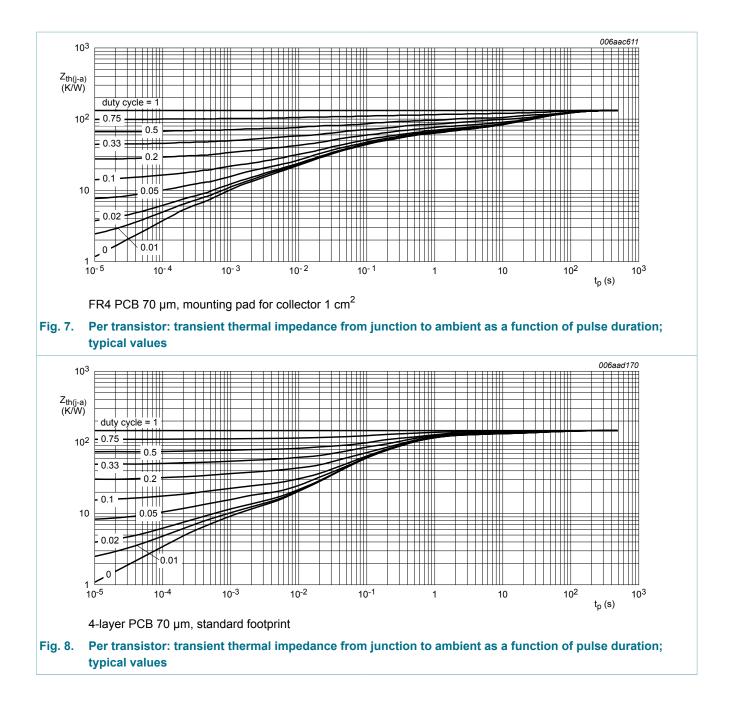


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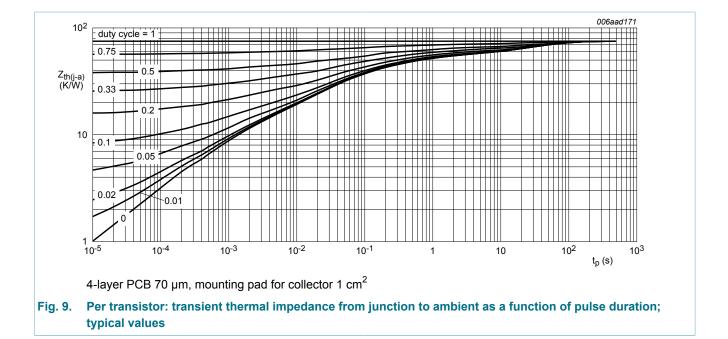






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### **10. Characteristics**

#### Table 7. Characteristics

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
TR1 (NPN)						
I <sub>CBO</sub>	collector-base cut-off	V <sub>CB</sub> = 24 V; I <sub>E</sub> = 0 A; T <sub>amb</sub> = 25 °C	-	-	100	nA
	current	V <sub>CB</sub> = 24 V; I <sub>E</sub> = 0 A; T <sub>j</sub> = 150 °C	-	-	50	μA
ЕВО	emitter-base cut-off current	V <sub>EB</sub> = 5 V; I <sub>C</sub> = 0 A; T <sub>amb</sub> = 25 °C	-	-	100	nA
h <sub>FE</sub>	DC current gain	$V_{CE} = 2 \text{ V; } I_C = 100 \text{ mA; pulsed;}$ $t_p \le 300  \mu\text{s; } \delta \le 0.02 \text{ ; } T_{amb} = 25 ^\circ\text{C}$	250	380	-	
		$V_{CE} = 2 \text{ V; } I_C = 500 \text{ mA; pulsed;}$ $t_p \le 300  \mu\text{s; } \delta \le 0.02 \text{ ; } T_{amb} = 25 ^\circ\text{C}$	230	350	-	
		$\label{eq:VCE} \begin{array}{l} V_{CE} = 2 \; V; \; I_C = 1 \; A; \; pulsed; \; t_p \leq 300 \; \mu s; \\ \delta \leq 0.02 \; ; \; T_{amb} = 25 \; ^\circ C \end{array}$	200	310	-	
		$V_{CE} = 2 \text{ V}; \text{ I}_{C} = 2 \text{ A}; \text{ pulsed};  \text{t}_{p} \leq 300  \mu\text{s};$ $\delta \leq 0.02 \text{ ; } \text{ T}_{amb} = 25 ^{\circ}\text{C}$	150	230	-	
V <sub>CEsat</sub>	collector-emitter	$I_{C}$ = 500 mA; $I_{B}$ = 50 mA; $T_{amb}$ = 25 °C	-	60	80	mV
	saturation voltage	$I_{C}$ = 1 A; $I_{B}$ = 50 mA; pulsed; t <sub>p</sub> ≤ 300 μs; δ ≤ 0.02 ; T <sub>amb</sub> = 25 °C	-	120	160	mV
		$I_{C}$ = 2 A; $I_{B}$ = 100 mA; pulsed; $t_{p} \le 300 \ \mu$ s; δ $\le 0.02$ ; $T_{amb}$ = 25 °C	-	230	300	mV
		$I_{C}$ = 2 A; $I_{B}$ = 200 mA; pulsed; $t_{p} \le 300 \ \mu s$ ; $\overline{\delta} \le 0.02$ ; $T_{amb}$ = 25 °C	-	220	290	mV

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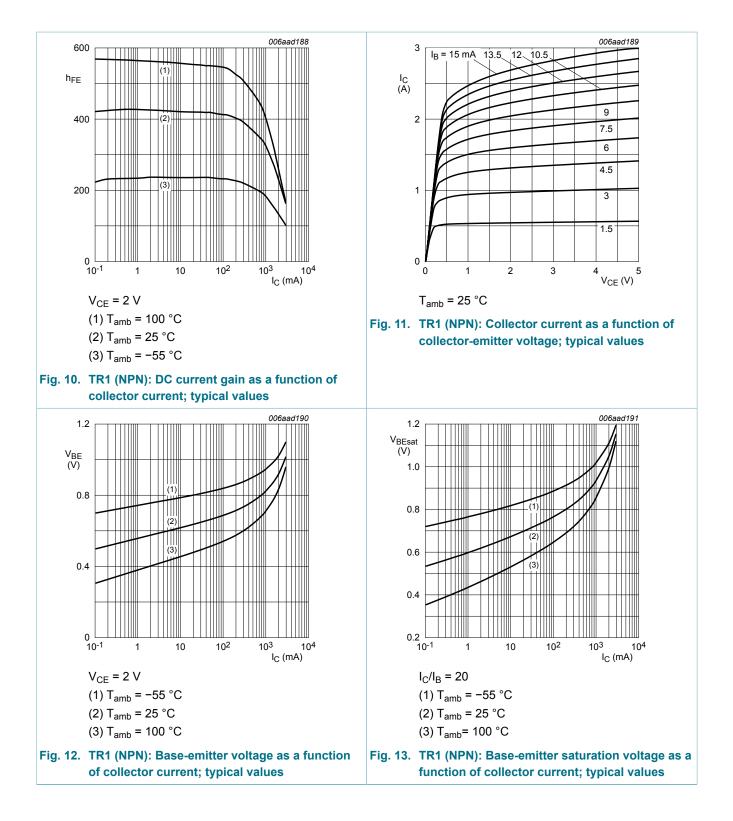
Symbol	Parameter	Conditions	Min	Тур	Max	Unit
R <sub>CEsat</sub>	collector-emitter saturation resistance	$\begin{split} I_{C} &= 1 \text{ A};  I_{B} = 100 \text{ mA}; \text{ pulsed}; \\ t_{p} &\leq 300  \mu\text{s};  \delta \leq 0.02 ;  T_{amb} = 25 ^{\circ}\text{C} \end{split}$	-	-	145	mΩ
V <sub>BEsat</sub>	base-emitter saturation	$I_{\rm C}$ = 500 mA; $I_{\rm B}$ = 50 mA; $T_{\rm amb}$ = 25 °C	-	-	1	V
	voltage	$\begin{split} I_{C} &= 1 \text{ A};  I_{B} = 50 \text{ mA}; \text{ pulsed}; \\ t_{p} &\leq 300  \mu\text{s};  \delta &\leq 0.02 ;  T_{amb} = 25 ^{\circ}\text{C} \end{split}$	-	-	1	V
		$I_{C}$ = 2 A; $I_{B}$ = 100 mA; pulsed; $t_{p} \le 300 \ \mu$ s; δ ≤ 0.02 ; $T_{amb}$ = 25 °C	-	-	1.1	V
		$I_{C}$ = 2 A; $I_{B}$ = 200 mA; pulsed; $t_{p} \le 300 \ \mu$ s; δ ≤ 0.02 ; $T_{amb}$ = 25 °C	-	-	1.2	V
V <sub>BEon</sub>	base-emitter turn-on voltage	$V_{CE} = 2 \text{ V}; \text{ I}_{C} = 0.5 \text{ A}; \text{ pulsed};$ $t_{p} \leq 300  \mu\text{s};  \delta \leq 0.02 ;  \text{T}_{amb} = 25 ^{\circ}\text{C}$	-	-	0.9	V
t <sub>d</sub>	delay time	$V_{CC}$ = 12.5 V; I <sub>C</sub> = 1 A; I <sub>Bon</sub> = 50 mA;	-	10	-	ns
t <sub>r</sub>	rise time	$_{Boff} = -50 \text{ mA}; T_{amb} = 25 \text{ °C}$ - 50 - 60 - 310 - 60	50	-	ns	
t <sub>on</sub>	turn-on time	-	-	60	-	ns
t <sub>s</sub>	storage time		-	310	-	ns
t <sub>f</sub>	fall time		-	60	-	ns
t <sub>off</sub>	turn-off time	-	-	370	-	ns
f <sub>T</sub>	transition frequency	V <sub>CE</sub> = 10 V; I <sub>C</sub> = 50 mA; f = 100 MHz; T <sub>amb</sub> = 25 °C	60	120	-	MHz
C <sub>c</sub>	collector capacitance	V <sub>CB</sub> = 10 V; I <sub>E</sub> = 0 A; i <sub>e</sub> = 0 A; f = 1 MHz; T <sub>amb</sub> = 25 °C	-	13.5	18	pF
TR2 (PNP)			I			
I <sub>CBO</sub>	collector-base cut-off	V <sub>CB</sub> = -24 V; I <sub>E</sub> = 0 A	-	-	-100	nA
	current	V <sub>CB</sub> = -24 V; I <sub>E</sub> = 0 A; T <sub>j</sub> = 150 °C	-	-	-50	μA
I <sub>EBO</sub>	emitter-base cut-off current	V <sub>EB</sub> = -5 V; I <sub>C</sub> = 0 A	-	-	-100	nA
h <sub>FE</sub>	DC current gain	$    V_{CE} = -2 \text{ V; } I_{C} = -100 \text{ mA; pulsed;}                                    $	260	370	-	
		$\begin{split} V_{CE} &= -2 \ V; \ I_C = -500 \ m\text{A}; \ pulsed; \\ t_p &\leq 300 \ \mu\text{s}; \ \delta &\leq 0.02 \ ; \ T_{amb} = 25 \ ^\circ\text{C} \end{split}$	210	290	-	
		$V_{CE}$ = -2 V; I <sub>C</sub> = -1 A; pulsed; t <sub>p</sub> ≤ 300 µs; $\delta$ ≤ 0.02 ; T <sub>amb</sub> = 25 °C	160	230	-	
		$V_{CE}$ = -2 V; I <sub>C</sub> = -2 A; pulsed; t <sub>p</sub> ≤ 300 µs; $\delta$ ≤ 0.02 ; T <sub>amb</sub> = 25 °C	100	145	-	
V <sub>CEsat</sub>	collector-emitter saturation voltage	$I_C$ = -500 mA; $I_B$ = -50 mA; pulsed; $t_p$ ≤ 300 μs; δ ≤ 0.02 ; $T_{amb}$ = 25 °C	-	-75 -110	-110	mV
		$I_{C}$ = -1 A; $I_{B}$ = -50 mA; pulsed; $t_{p} \le 300 \ \mu$ s; δ ≤ 0.02 ; $T_{amb}$ = 25 °C	-	-155	-220	mV

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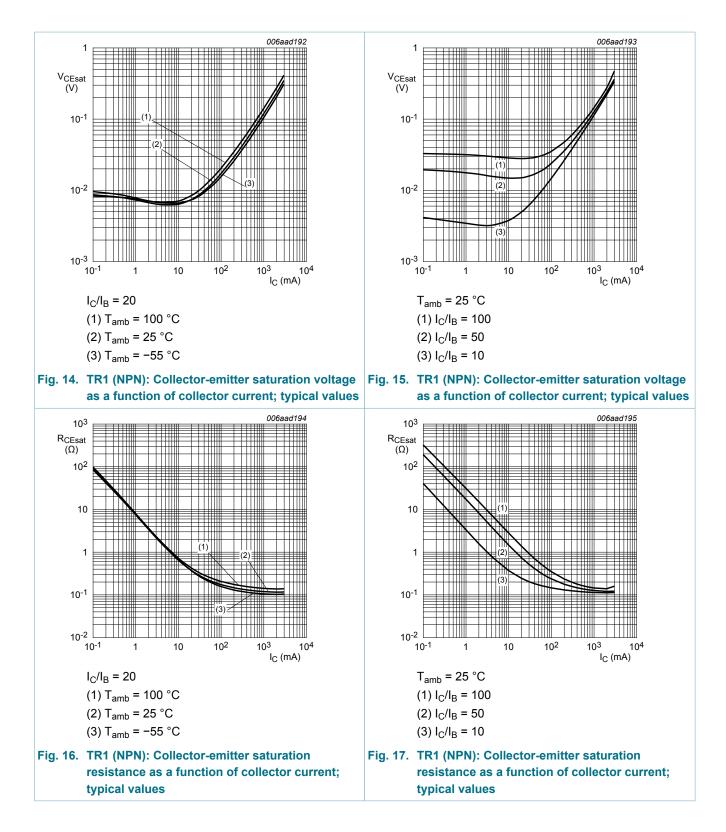
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Symbol	Parameter	Conditions	Min	Тур	Max	Unit
		$I_{C}$ = -2 A; $I_{B}$ = -100 mA; pulsed; $t_{p} \le 300 \ \mu$ s; δ ≤ 0.02 ; $T_{amb}$ = 25 °C	-	-295	-420	mV
		$I_{C}$ = -2 A; $I_{B}$ = -200 mA; pulsed; $t_{p}$ ≤ 300 µs; δ ≤ 0.02 ; $T_{amb}$ = 25 °C	-	-275	-390	mV
R <sub>CEsat</sub>	collector-emitter saturation resistance	$I_{C}$ = -1 A; $I_{B}$ = -100 mA; pulsed; $t_{p} \le 300 \ \mu$ s; δ $\le 0.02$ ; $T_{amb}$ = 25 °C	-	-	195	mΩ
V <sub>BEsat</sub>	base-emitter saturation voltage	$I_C$ = -500 mA; $I_B$ = -50 mA; pulsed; $t_p$ ≤ 300 μs; δ ≤ 0.02 ; $T_{amb}$ = 25 °C	-	-	-1	V
		$I_{C}$ = -1 A; $I_{B}$ = -50 mA; pulsed; $t_{p} \le 300$ μs; δ $\le 0.02$ ; $T_{amb}$ = 25 °C	-	-	-1	V
		$I_C$ = -2 A; $I_B$ = -100 mA; pulsed; t <sub>p</sub> ≤ 300 μs; δ ≤ 0.02 ; $T_{amb}$ = 25 °C	-	-	-1.1	V
		$I_{C}$ = -2 A; $I_{B}$ = -200 mA; pulsed; $t_{p} \le 300 \ \mu$ s; δ ≤ 0.02 ; $T_{amb}$ = 25 °C	-	-	-1.2	V
V <sub>BEon</sub>	base-emitter turn-on voltage	$\label{eq:VcE} \begin{array}{l} V_{CE} \texttt{=} \texttt{-2} \; V \texttt{;} \; I_{C} \texttt{=} \texttt{-0.5} \; A \texttt{;} \; \texttt{pulsed} \texttt{;} \\ t_{p} \texttt{\leq} \texttt{300} \; \mu \texttt{s} \texttt{;} \; \bar{0} \texttt{\leq} \texttt{0.02} \texttt{;} \; T_{amb} \texttt{=} \texttt{25} \; ^{\circ} C \end{array}$	-	-	-0.9	V
t <sub>d</sub>	delay time	$V_{CC}$ = -12.5 V; $I_{C}$ = -1 A; $I_{Bon}$ = -0.05 A;	-	10	-	ns
t <sub>r</sub>	rise time	I <sub>Boff</sub> = 0.05 A; T <sub>amb</sub> = 25 °C	-	50	-	ns
t <sub>on</sub>	turn-on time		-	60	-	ns
t <sub>s</sub>	storage time		-	200	-	ns
t <sub>f</sub>	fall time		-	45	-	ns
t <sub>off</sub>	turn-off time		-	245	-	ns
f <sub>T</sub>	transition frequency	$V_{CE}$ = -10 V; I <sub>C</sub> = -50 mA; f = 100 MHz; T <sub>amb</sub> = 25 °C	50	95	-	MHz
C <sub>c</sub>	collector capacitance	V <sub>CB</sub> = -10 V; I <sub>E</sub> = 0 A; i <sub>e</sub> = 0 A; f = 1 MHz; T <sub>amb</sub> = 25 °C	-	22	29	pF

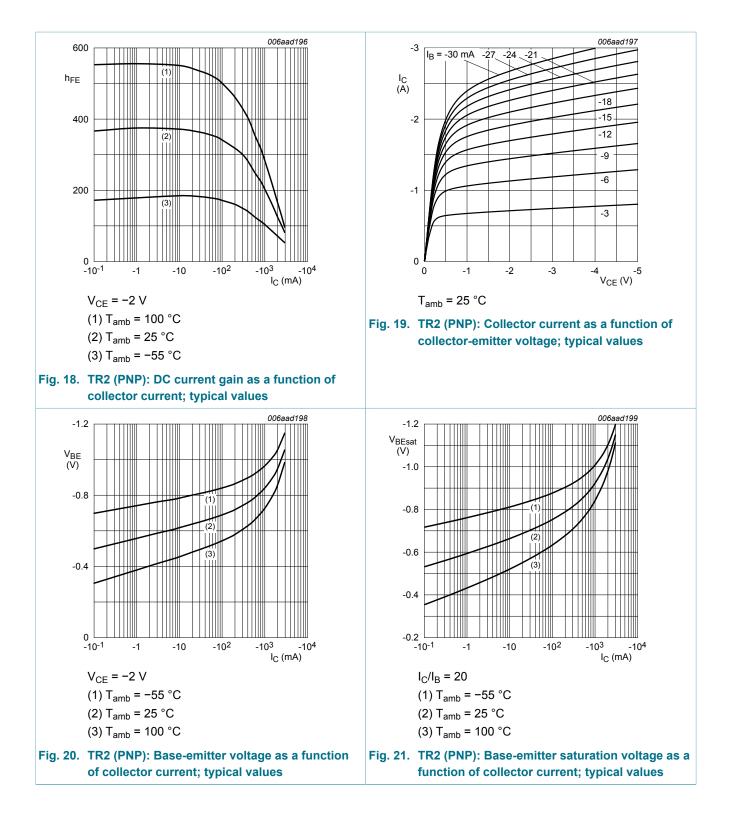


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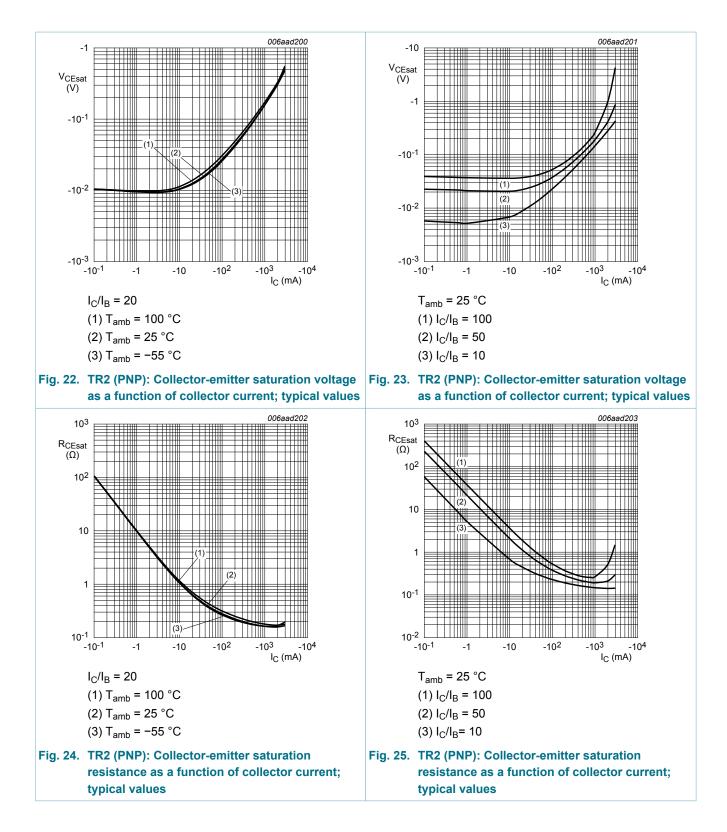


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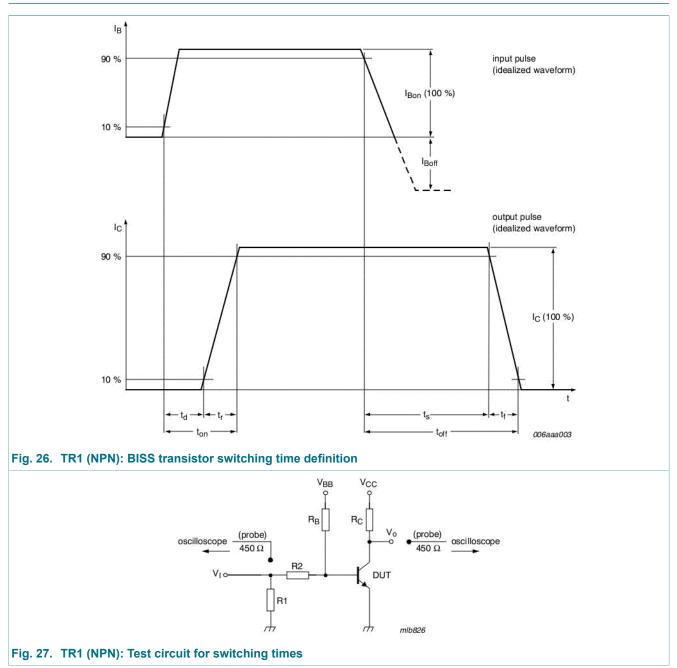
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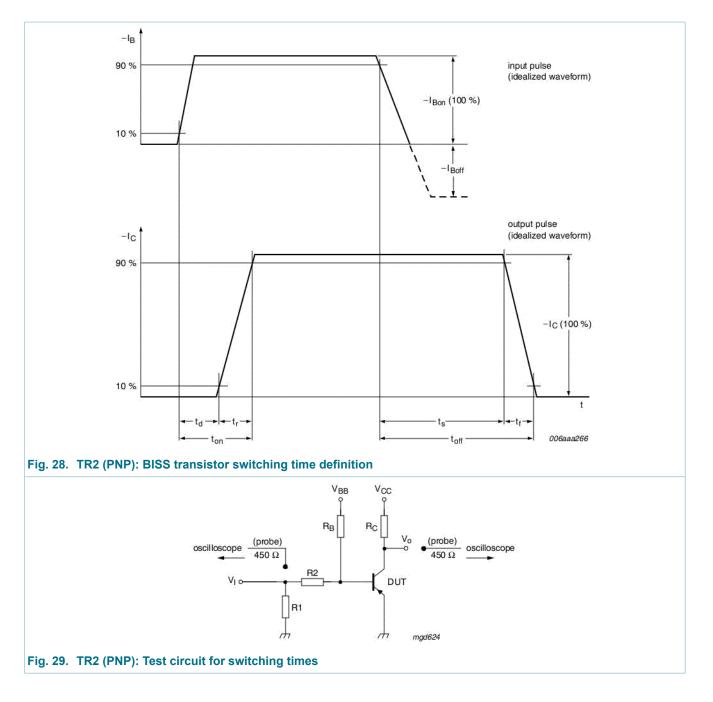


# **11. Test information**

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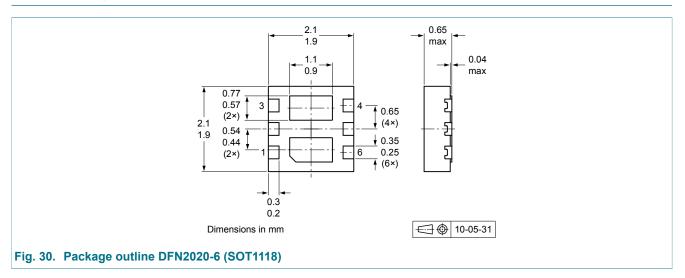
### **11.1 Quality information**

This product has been qualified in accordance with the Automotive Electronics Council (AEC) standard *Q101* - *Stress test qualification for discrete semiconductors*, and is suitable for use in automotive applications.

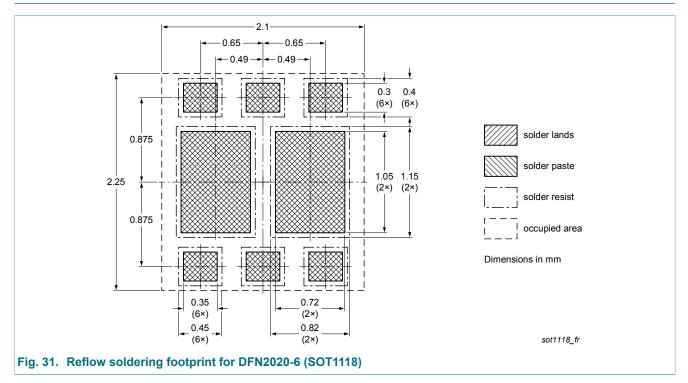
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### 12. Package outline



### 13. Soldering



### 14. Revision history

Table 8. Revision hi	story			
Data sheet ID	Release date	Data sheet status	Change notice	Supersedes
PBSS4230PANP v.1	20121214	Product data sheet	-	-
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Product data sheet 14 December 2012			18 / 21	

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### 15. Legal information

#### 15.1 Data sheet status

Document status [1][2]	Product status [ <u>3]</u>	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

 Please consult the most recently issued document before initiating or completing a design.

[2] The term 'short data sheet' is explained in section "Definitions".

[3] The product status of device(s) described in this document may have changed since this document was published and may differ in case of multiple devices. The latest product status information is available on the Internet at URL <u>http://www.nexperia.com</u>.

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